<u>MOSFET</u> – Power, Single N-Channel 80 V, 2.1 mΩ, 203 A

Features

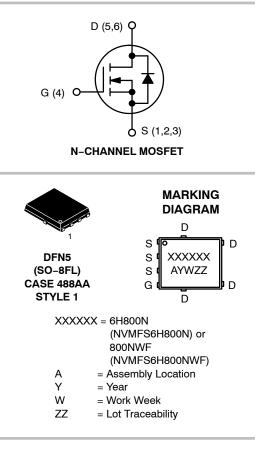
- Small Footprint (5x6 mm) for Compact Design
- Low R_{DS(on)} to Minimize Conduction Losses
- Low Q_G and Capacitance to Minimize Driver Losses
- NVMFS6H800NWF Wettable Flank Option for Enhanced Optical Inspection
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant



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V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX
80 V	2.1 mΩ @ 10 V	203 A



MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Parameter		Symbol	Value	Unit			
Drain-to-Source Voltage		V _{DSS}	80	V			
Gate-to-Source Voltage	e		V _{GS}	±20	V		
Continuous Drain		$T_{C} = 25^{\circ}C$	I _D	203	А		
Current R _{θJC} (Notes 1, 3)	Steady	T _C = 100°C		143			
Power Dissipation	State	T _C = 25°C	PD	200	W		
R _{θJC} (Note 1)		$T_{\rm C} = 100^{\circ}{\rm C}$		100			
Continuous Drain		$T_A = 25^{\circ}C$	I _D	28	А		
Current R _{θJA} (Notes 1, 2, 3)	Steady State	T _A = 100°C		20			
Power Dissipation		T _A = 25°C	PD	3.8	W		
$R_{\theta JA}$ (Notes 1 & 2)		T _A = 100°C		1.9			
Pulsed Drain Current	$T_A = 25^{\circ}C, t_p = 10 \ \mu s$		I _{DM}	900	А		
Operating Junction and Storage Temperature			T _J , T _{stg}	–55 to + 175	°C		
Source Current (Body Diode)			۱ _S	166	А		
Single Pulse Drain-to-Source Avalanche Energy (I _{L(pk)} = 16.1 A)		E _{AS}	1271	mJ			
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)					ΤL	260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State	$R_{\theta JC}$	0.75	°C/W
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta JA}$	39	

1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

2. Surface-mounted on FR4 board using a 650 mm², 2 oz. Cu pad.

Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.

ORDERING INFORMATION

See detailed ordering, marking and shipping information in the package dimensions section on page 5 of this data sheet.

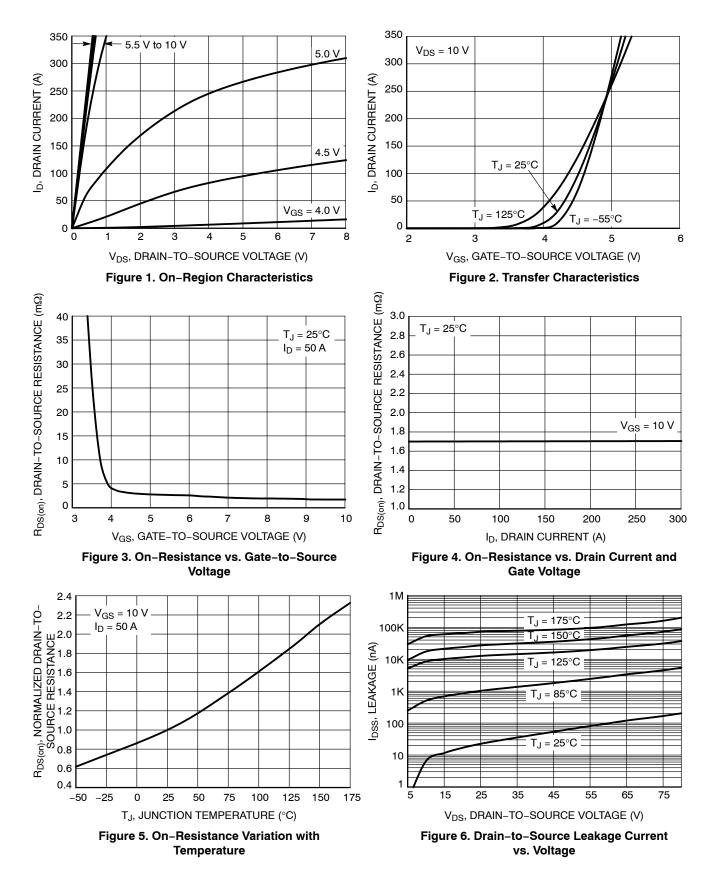
ELECTRICAL CHARACTERISTICS (T_J = $25^{\circ}C$ unless otherwise specified)

Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS							
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I _D = 250 µA		80			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} / T _J				39		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	$V_{GS} = 0 V$, $T_J = 25 °C$				10	
		V _{DS} = 80 V T _J =	T _J = 125°C			250	μΑ
Gate-to-Source Leakage Current	I _{GSS}	$V_{DS} = 0 V, V_{G}$	_{iS} = 20 V			100	nA
ON CHARACTERISTICS (Note 4)							
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_D$	= 330 μA	2.0		4.0	V
Threshold Temperature Coefficient	V _{GS(TH)} /T _J				8.0		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 50 A		1.8	2.1	mΩ
Forward Transconductance	9 _{FS}	V _{DS} =15 V, I	_D = 50 A		138		S
CHARGES, CAPACITANCES & GATE RE	SISTANCE						
Input Capacitance	C _{ISS}	V _{GS} = 0 V, f = 1 MHz, V _{DS} = 40 V			5530		pF
Output Capacitance	C _{OSS}				760		
Reverse Transfer Capacitance	C _{RSS}				27		
Total Gate Charge	Q _{G(TOT)}	V_{GS} = 10 V, V_{DS} = 40 V; I_{D} = 50 A			85		
Threshold Gate Charge	Q _{G(TH)}	V _{GS} = 10 V, V _{DS} = 40 V; I _D = 50 A			15		nC
Gate-to-Source Charge	Q _{GS}				26		
Gate-to-Drain Charge	Q _{GD}				16		
Plateau Voltage	V _{GP}				4.8		V
SWITCHING CHARACTERISTICS (Note 5	5)						
Turn-On Delay Time	t _{d(ON)}				25		
Rise Time	t _r	V _{GS} = 10 V. Vr	_{DS} = 64 V,		89		1
Turn-Off Delay Time	t _{d(OFF)}	$\label{eq:VGS} \begin{array}{l} V_{GS} = 10 \; V, \; V_{DS} = 64 \; V, \\ I_{D} = 50 \; A, \; R_{G} = 2.5 \; \Omega \end{array}$			97		- ns
Fall Time	t _f				85		
DRAIN-SOURCE DIODE CHARACTERIS	STICS						
Forward Diode Voltage	V _{SD}	V _{GS} = 0 V,	$T_J = 25^{\circ}C$		0.8	1.2	V
	$I_{\rm S} = 50 \text{A}$	T _J = 125°C	C 0.7				
Reverse Recovery Time	t _{RR}	V _{GS} = 0 V, dIS/dt = 100 A/µs, I _S = 50 A			76		
Charge Time	t _a				36		ns
Discharge Time	t _b				40		
Reverse Recovery Charge	Q _{RR}				82		nC

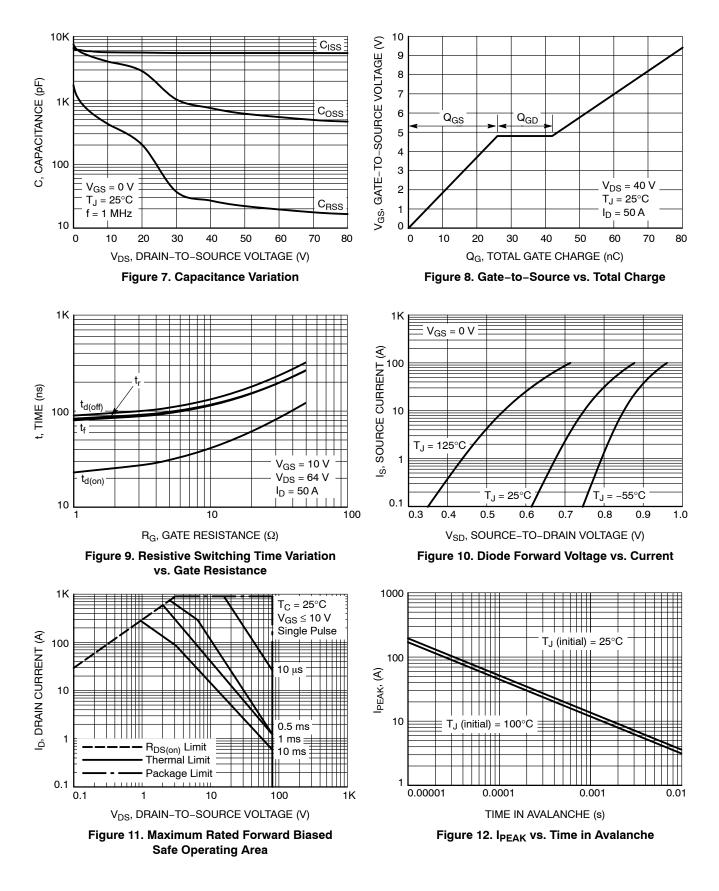
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Pulse Test: pulse width $\leq 300 \ \mu$ s, duty cycle $\leq 2\%$.

5. Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS

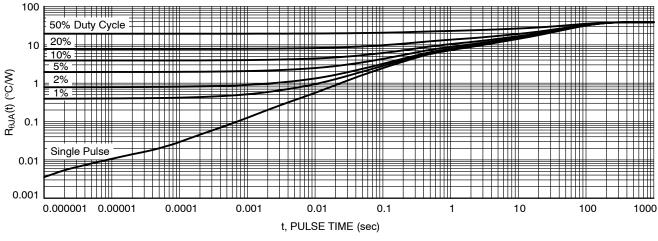


Figure 13. Thermal Response

Device	Marking	Package	Shipping [†]			
NVMFS6H800NT1G	6H800N	DFN5 (Pb–Free)	1500 / Tape & Reel			
NVMFS6H800NWFT1G	800NWF	DFN5 (Pb-Free, Wettable Flanks)	1500 / Tape & Reel			

DEVICE ORDERING INFORMATION

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.





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